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# 30-EQ12NAA003MS04-PT18F76T

datasheet

flowANPC E3BP

1200 V / 2,83 mΩ

## Topology features

- Kelvin Emitter for improved switching performance
- Temperature sensor
- Advanced Neutral Point Clamped topology
- Gate Resistor

## Component features

- High Blocking Voltage with low drain source on state resistance
- High speed SiC-MOSFET technology
- Resistant to Latch-up

## Housing features

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- Cu baseplate
- Convex shaped baseplate for superior thermal contact
- CTI600 housing material
- Baseplate with rough surface
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

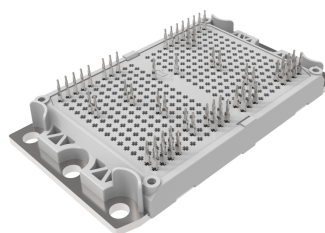
## Target applications

- Energy Storage Systems

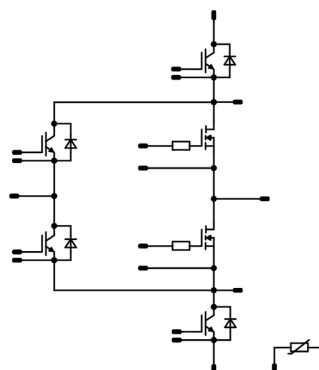
## Types

- 30-EQ12NAA003MS04-PT18F76T

## flow E3BP 15 mm housing



## Schematic





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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>AC Switch</b>				
Drain-source voltage	$V_{DSS}$		1200	V
Drain current (DC current)	$I_D$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	306	A
Peak drain current	$I_{DM}$	$t_p$ limited by $T_{jmax}$	1704	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	373	W
Gate-source voltage	$V_{GSS}$	static	-5 / 18	V
		dynamic	-10 / 22	V
Maximum Junction Temperature	$T_{jmax}$		175	°C

## Neutral Point Switch

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	198	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	365	W
Gate-emitter voltage	$V_{GES}$		±20	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 175\text{ °C}$	7	µs
Maximum junction temperature	$T_{jmax}$		175	°C

## DC-Link Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	205	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	600	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	330	W
Maximum junction temperature	$T_{jmax}$		175	°C



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### DC-Link Switch

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	198	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	365	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 175\text{ °C}$	7	$\mu s$
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Neutral Point Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	140	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	233	W
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Resistor (Gate)

DC current	$I$	terminal temperature $T_k = 90\text{ °C}$	2121	mA
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	1,5	W
Operation Temperature	$T_{op}$		-55 ... 155	$^{\circ}\text{C}$



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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## Module Properties

### Thermal Properties

Storage temperature	$T_{\text{stg}}$		-40...+125	°C
Operation temperature under switching condition	$T_{\text{jop}}$		-40...+( $T_{\text{jmax}}$ - 25)	°C

### Isolation Properties

Isolation voltage	$V_{\text{isol}}$	DC Test Voltage* $t_p = 2\text{ s}$	6800	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 600	

\*100 % tested in production





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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### AC Switch

#### Static

Drain-source on-state resistance	$r_{DS(on)}$		18		426	25 125 150		2,89 3,6 3,96	4,17 <sup>(1)</sup>	mΩ
Gate-source threshold voltage	$V_{GS(th)}$				0,0426	25	1,7	2,25	2,75	V
Gate to Source Leakage Current	$I_{GSS}$		22	0		25			600	nA
Zero Gate Voltage Drain Current	$I_{DSS}$		0	1200		25			60	μA
Internal gate resistance	$r_g$							0,167		Ω
Gate charge	$Q_g$		-5/18	800	426	25		1128		nC
Short-circuit input capacitance	$C_{iss}$	$f = 500$ kHz	0	800	0	25		28080		pF
Short-circuit output capacitance	$C_{oss}$							1410		
Reverse transfer capacitance	$C_{rss}$							48		
Diode forward voltage	$V_{SD}$		0		426	25		4,1		V

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,25		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit	
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		
Dynamic											
Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \ \Omega$ $R_{goff} = 4 \ \Omega$	-5/18	600	200	25		99,87		ns	
						125		84,27			
						150		81,17			
Rise time	$t_r$					25		52,63		ns	
						125		41,45			
						150		39,17			
Turn-off delay time	$t_{d(off)}$					25		223,85		ns	
						125		258,37			
						150		265,72			
Fall time	$t_f$					25		28,33		ns	
						125		28,44			
						150		28,88			
Turn-on energy (per pulse)	$E_{on}$	$Q_{rFWD}=1,81 \ \mu C$ $Q_{rFWD}=3,53 \ \mu C$ $Q_{rFWD}=4,28 \ \mu C$	25		6,8		mWs				
			125		6,24						
			150		6,18						
Turn-off energy (per pulse)	$E_{off}$		25		3,23		mWs				
			125		3,47						
			150		3,4						
Peak recovery current	$I_{RRM}$	$di/dt=5321 \ A/\mu s$ $di/dt=5442 \ A/\mu s$ $di/dt=5756 \ A/\mu s$	25		82,05		A				
			125		126,42						
			150		143,71						
Reverse recovery time	$t_{rr}$		25		37,45		ns				
			125		46,4						
			150		48,79						
Recovered charge	$Q_r$		25		1,81		$\mu C$				
			125		3,53						
			150		4,28						
Reverse recovered energy	$E_{rec}$	25		0,287		mWs					
		125		0,772							
		150		0,986							
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	25		5714,03		A/ $\mu s$					
		125		7122,32							
		150		8364,03							



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Neutral Point Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,005	25	5,15	5,8	6,45	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		200	25 125 150	1,3	1,57 1,75 1,81	1,7 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			18	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA
Internal gate resistance	$r_g$							0,75		Ω
Input capacitance	$C_{ies}$	$f = 100$ kHz	0	25		25		43400		pF
Reverse transfer capacitance	$C_{res}$							150		pF
Gate charge	$Q_g$	$V_{CC} = 600$ V	±15		200	25		3600		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,26		K/W
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### DC-Link Diode

#### Static

Forward voltage	$V_F$				300	25 125 150	1,45	1,91 1,93 1,91	1,95 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V				25			3	μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,29		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### DC-Link Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,005	25	5,15	5,8	6,45	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		200	25 125 150	1,3	1,57 1,75 1,81	1,7 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			18	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA
Internal gate resistance	$r_g$							0,75		Ω
Input capacitance	$C_{ies}$	$f = 100 \text{ kHz}$	0	25		25		43400		pF
Reverse transfer capacitance	$C_{res}$							150		pF
Gate charge	$Q_g$	$V_{CC} = 600 \text{ V}$	±15		200	25		3600		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2 \text{ W/mK}$ (PTM)						0,26		K/W
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### Neutral Point Diode

#### Static

Forward voltage	$V_F$				200	25 125 150	1,45	1,93 1,98 1,96	1,95 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200 \text{ V}$				25			2	μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 5,2 \text{ W/mK}$ (PTM)						0,41		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Resistor (Gate)

#### Static

Resistance	$R$							0,333		$\Omega$
Tolerance							-1		1	%
Temperature coefficient	tc							100		ppm/K

### Thermistor

#### Static

Rated resistance	$R$					25		22		k $\Omega$
Deviation of R100	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1$ %						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1$ %						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.

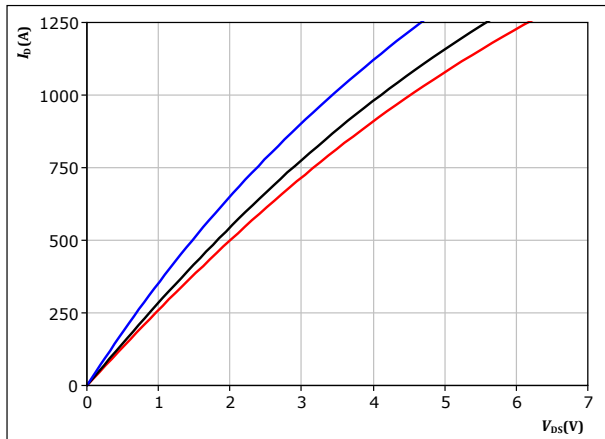


## AC Switch Characteristics

figure 1. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

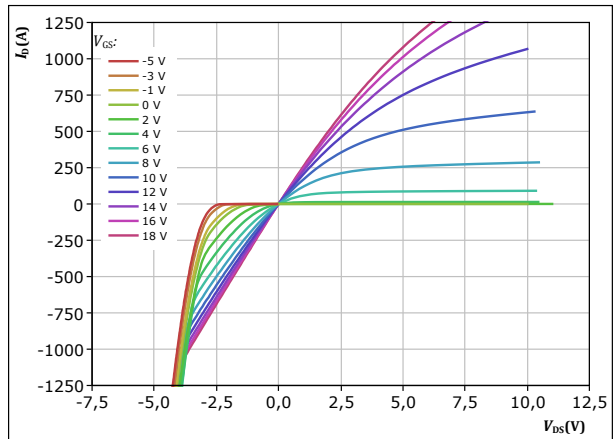


$t_p = 250 \mu s$   
 $V_{GS} = 18 V$   
 $T_j: 25 ^\circ C$   
 $125 ^\circ C$   
 $150 ^\circ C$

figure 2. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

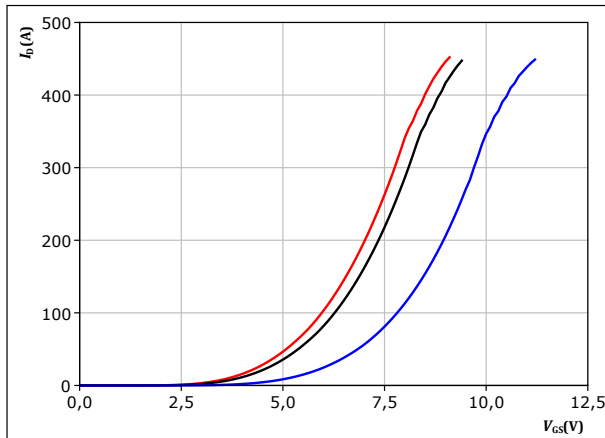


$t_p = 250 \mu s$   
 $T_j = 150 ^\circ C$   
 $V_{GS}$  from -5 V to 18 V in steps of 2 V

figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

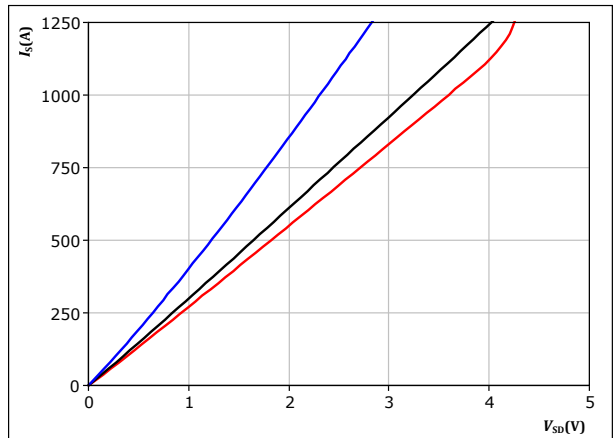


$t_p = 250 \mu s$   
 $V_{DS} = 27 V$   
 $T_j: 25 ^\circ C$   
 $125 ^\circ C$   
 $150 ^\circ C$

figure 4. MOSFET

Typical reverse drain current characteristics

$$I_{SD} = f(V_{SD})$$



$t_p = 250 \mu s$   
 $V_{GS} = 18 V$   
 $T_j: 25 ^\circ C$   
 $125 ^\circ C$   
 $150 ^\circ C$



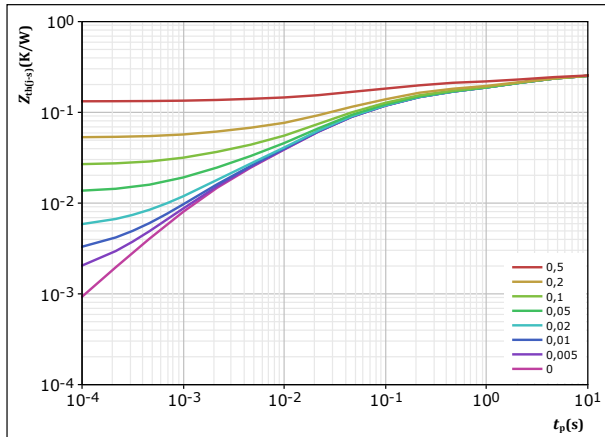
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## AC Switch Characteristics

figure 5. MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-a)} = f(t_p)$$



$$D = \frac{t_p}{T}$$

$$R_{th(j-a)} = 0,255 \text{ K/W}$$

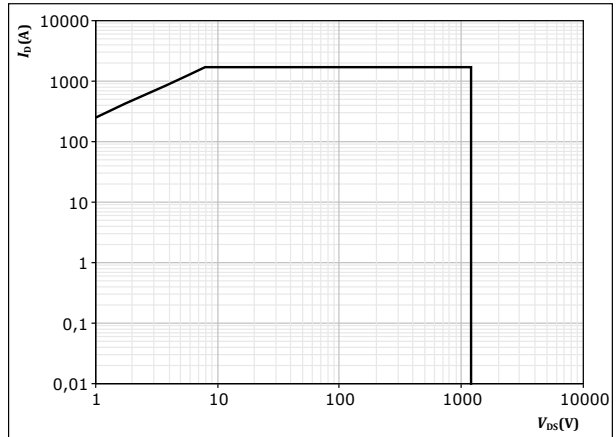
MOSFET thermal model values

$R$ (K/W)	$\tau$ (s)
5,02E-02	6,86E+00
6,29E-02	1,54E+00
8,60E-02	1,18E-01
5,39E-02	2,15E-02
1,16E-02	1,87E-03

figure 6. MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



$D = \text{single pulse}$

$$T_s = 80 \text{ } ^\circ\text{C}$$

$$V_{GS} = 18 \text{ V}$$

$$T_j = T_{jmax}$$



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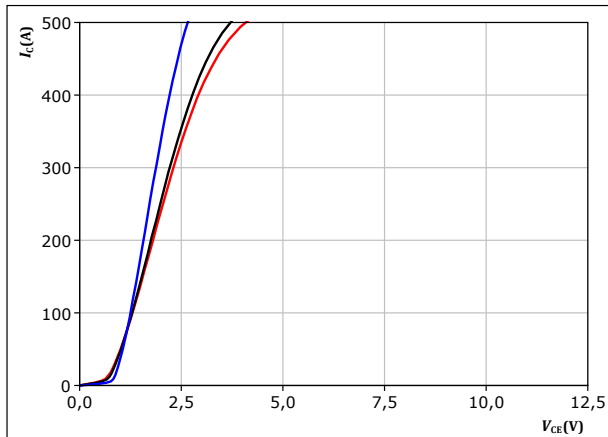
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## Neutral Point Switch Characteristics

figure 7. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

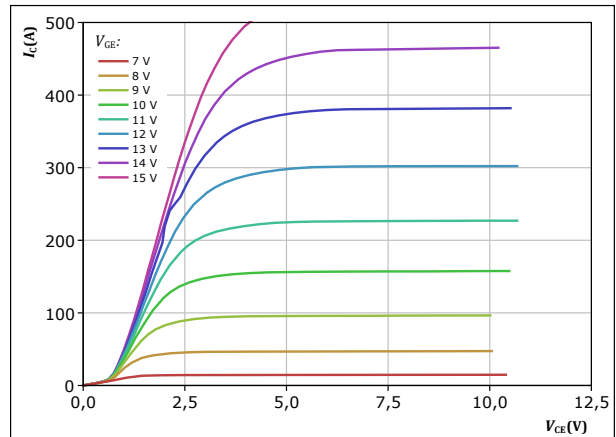


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ }^{\circ}\text{C}$   
 $125 \text{ }^{\circ}\text{C}$   
 $150 \text{ }^{\circ}\text{C}$

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

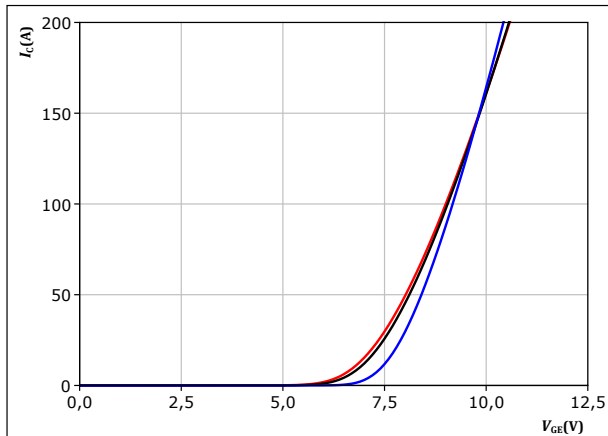


$t_p = 250 \mu s$   
 $T_j = 150 \text{ }^{\circ}\text{C}$   
 $V_{GE}$  from 7 V to 15 V in steps of 1 V

figure 9. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

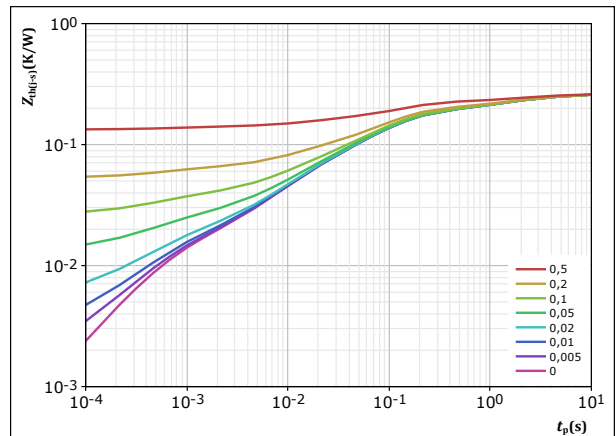


$t_p = 250 \mu s$   
 $V_{CE} = 30 V$   
 $T_j: 25 \text{ }^{\circ}\text{C}$   
 $125 \text{ }^{\circ}\text{C}$   
 $150 \text{ }^{\circ}\text{C}$

figure 10. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0.26 \text{ K/W}$   
IGBT thermal model values  

$R \text{ (K/W)}$	$\tau \text{ (s)}$
$3.01\text{E-}02$	$7.16\text{E+}00$
$5.88\text{E-}02$	$1.24\text{E+}00$
$1.31\text{E-}01$	$9.33\text{E-}02$
$3.45\text{E-}02$	$1.16\text{E-}02$
$1.17\text{E-}02$	$5.51\text{E-}04$





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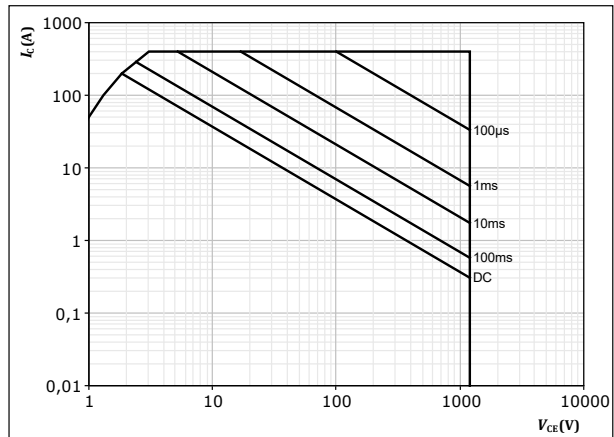
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## Neutral Point Switch Characteristics

figure 11. IGBT

Safe operating area

$$I_C = f(V_{CE})$$

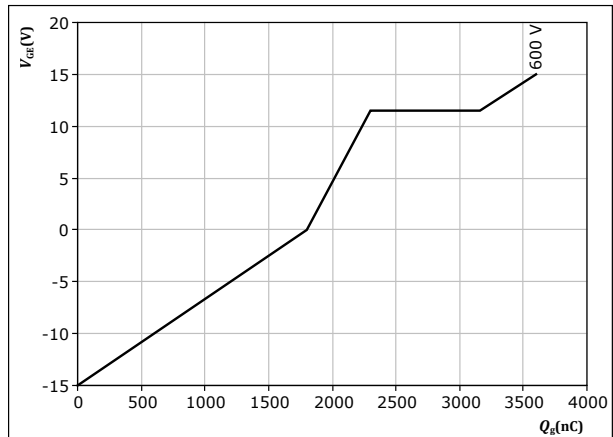


$D = \text{single pulse}$   
 $T_s = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j = T_{jmax}$

figure 12. IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 200 \text{ A}$   
 $T_j = 25 \text{ } ^\circ\text{C}$



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## DC-Link Diode Characteristics

figure 13.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

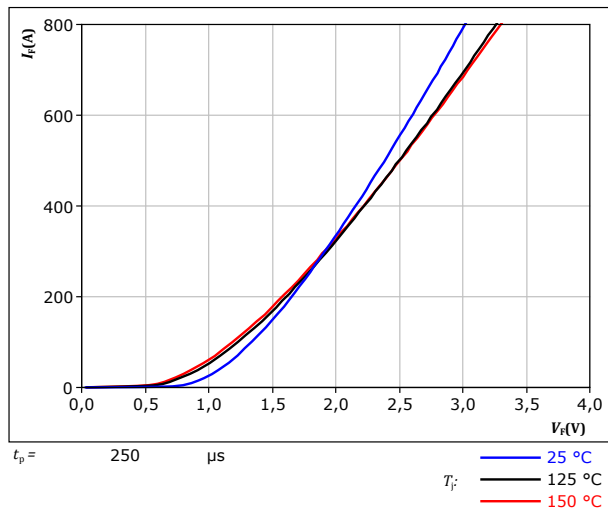
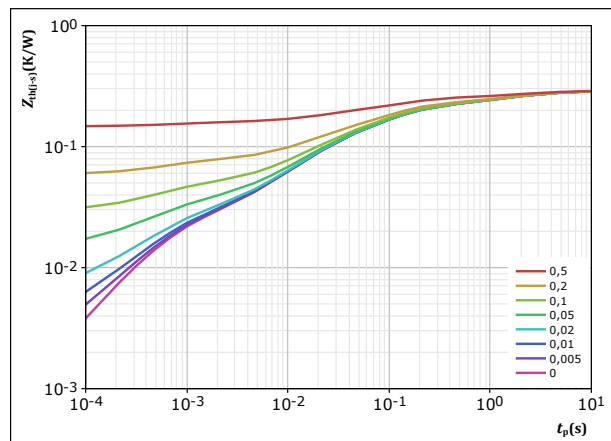


figure 14.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,288 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
2,83E-02	6,67E+00
6,00E-02	1,19E+00
1,19E-01	9,74E-02
6,55E-02	1,64E-02
2,01E-02	5,62E-04



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## DC-Link Switch Characteristics

figure 15. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

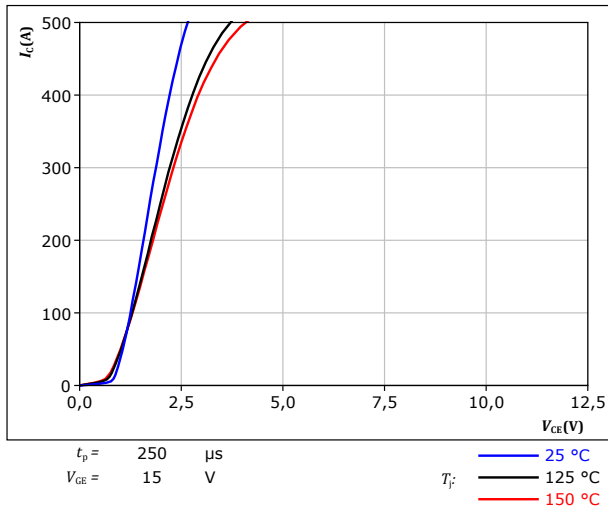


figure 17. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

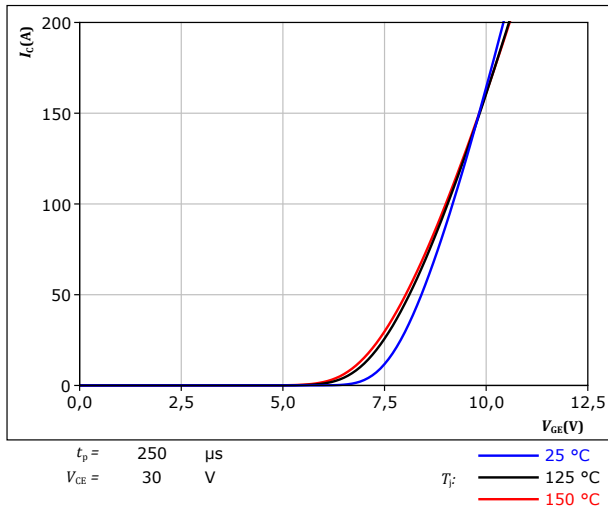


figure 16. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

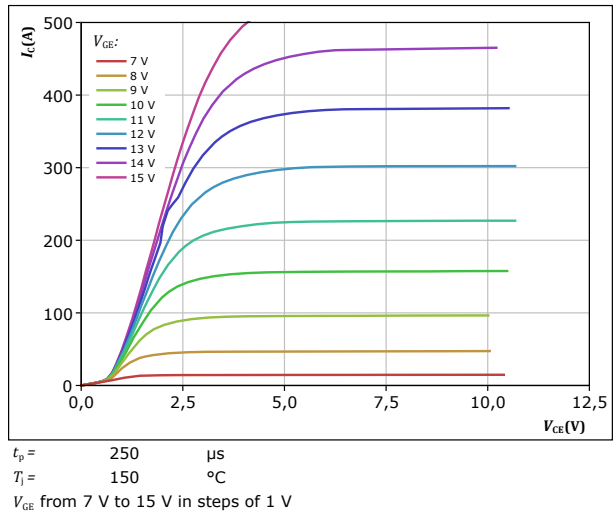
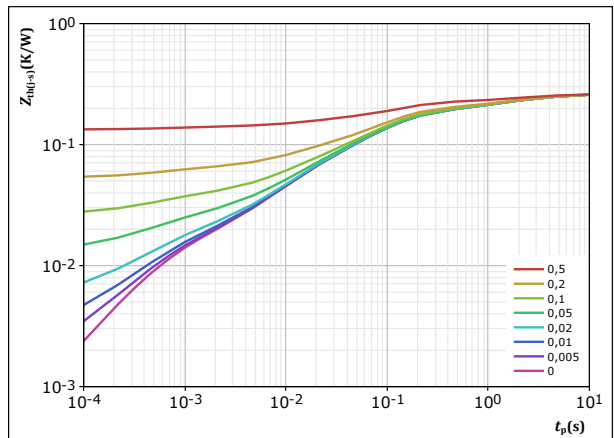


figure 18. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



IGBT thermal model values	
$R$ (K/W)	$\tau$ (s)
3,01E-02	7,16E+00
5,88E-02	1,24E+00
1,31E-01	9,33E-02
3,45E-02	1,16E-02
1,17E-02	5,51E-04



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# 30-EQ12NAA003MS04-PT18F76T

datasheet

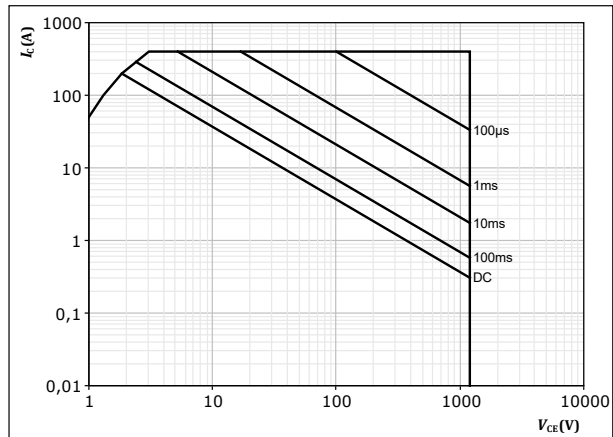
## DC-Link Switch Characteristics

figure 19.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



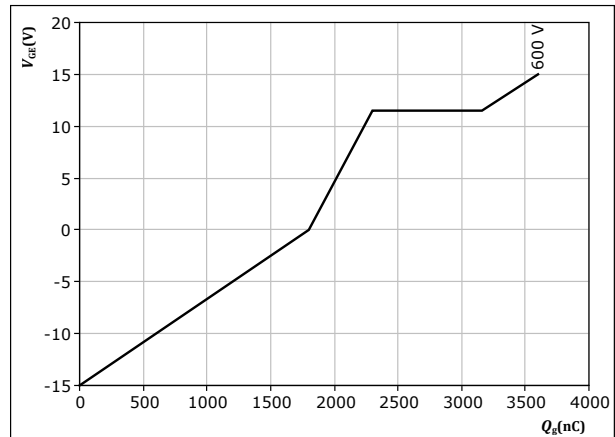
$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = 15$  V  
 $T_j = T_{jmax}$

figure 20.

IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 200$  A  
 $T_j = 25$  °C



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## Neutral Point Diode Characteristics

figure 21.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

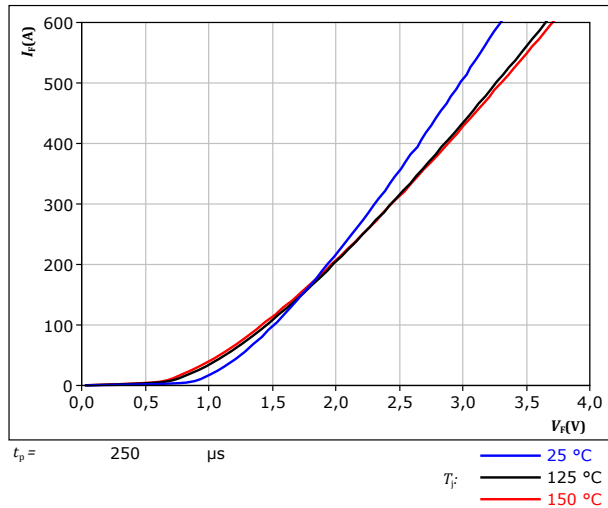
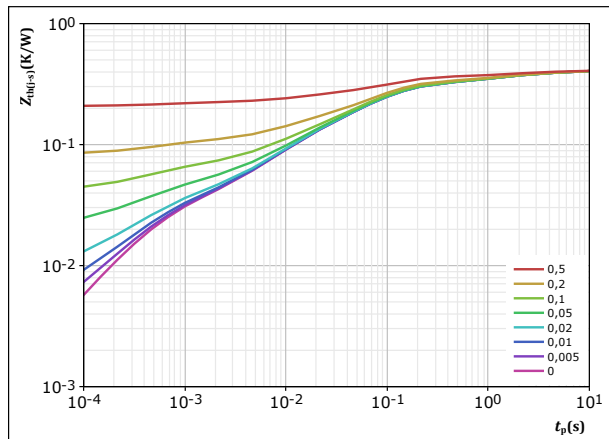


figure 22.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,407 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
3,87E-02	7,49E+00
7,42E-02	1,14E+00
2,15E-01	7,85E-02
6,19E-02	9,91E-03
2,50E-02	4,69E-04



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**30-EQ12NAA003MS04-PT18F76T**  
datasheet

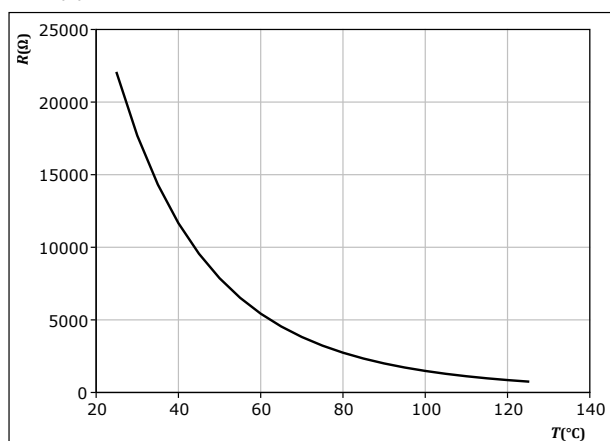
## Thermistor Characteristics

figure 23.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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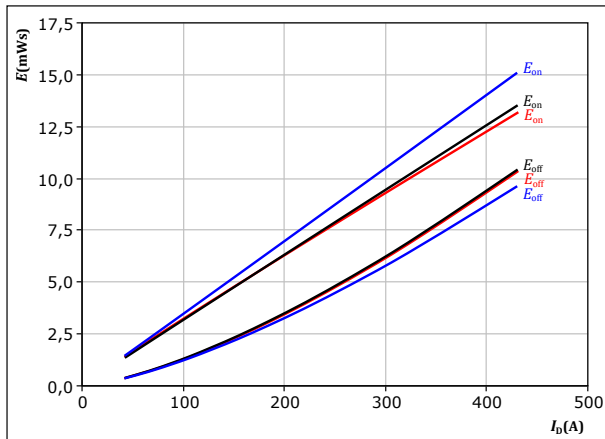
## AC Switching Characteristics

figure 24.

MOSFET

Typical switching energy losses as a function of drain current

$$E = f(I_D)$$



With an inductive load at

$V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$   $\Omega$   
 $R_{goff} = 4$   $\Omega$

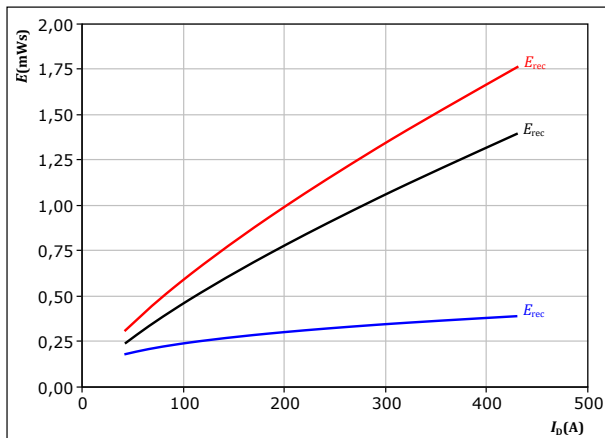
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 26.

MOSFET

Typical reverse recovered energy loss as a function of drain current

$$E_{rec} = f(I_D)$$



With an inductive load at

$V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$   $\Omega$

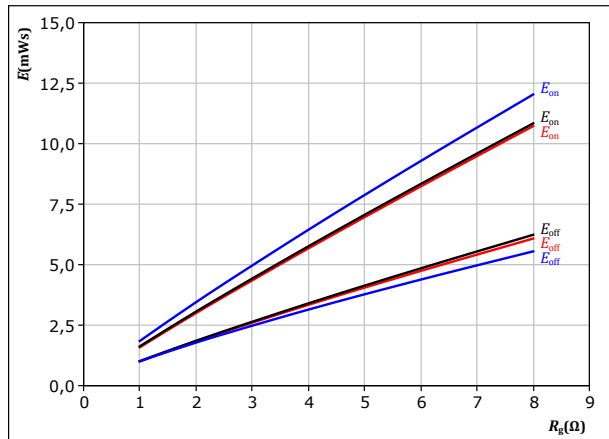
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 25.

MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A

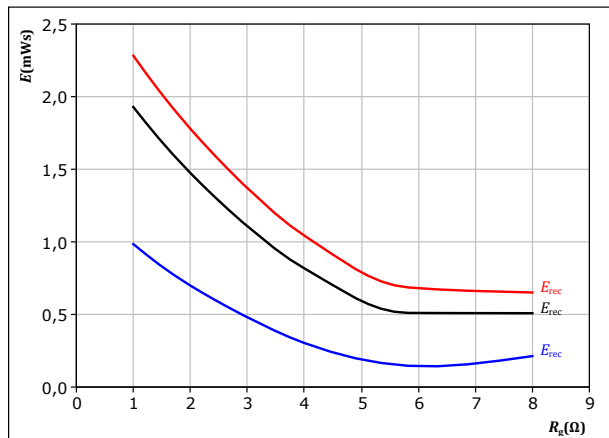
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 27.

MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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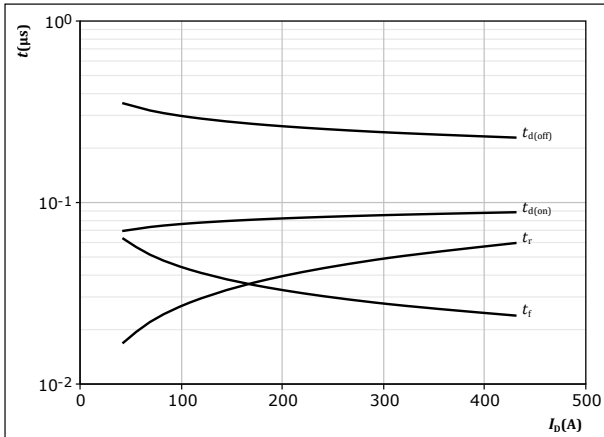
# 30-EQ12NAA003MS04-PT18F76T datasheet

## AC Switching Characteristics

figure 28.

MOSFET

Typical switching times as a function of drain current  
 $t = f(I_D)$



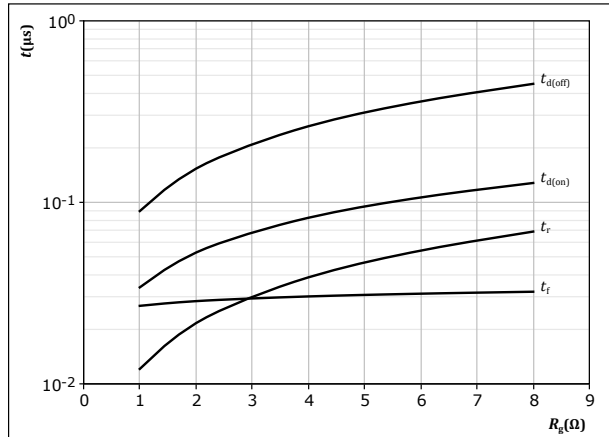
With an inductive load at

$T_j = 150$  °C  
 $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$  Ω  
 $R_{goff} = 4$  Ω

figure 29.

MOSFET

Typical switching times as a function of MOSFET turn on gate resistor  
 $t = f(R_g)$



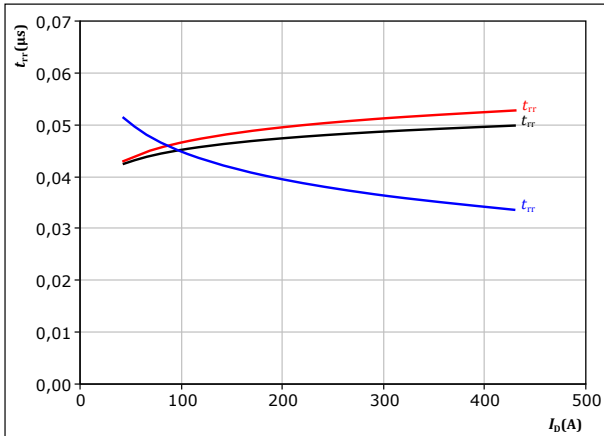
With an inductive load at

$T_j = 150$  °C  
 $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A

figure 30.

MOSFET

Typical reverse recovery time as a function of drain current  
 $t_{rr} = f(I_D)$

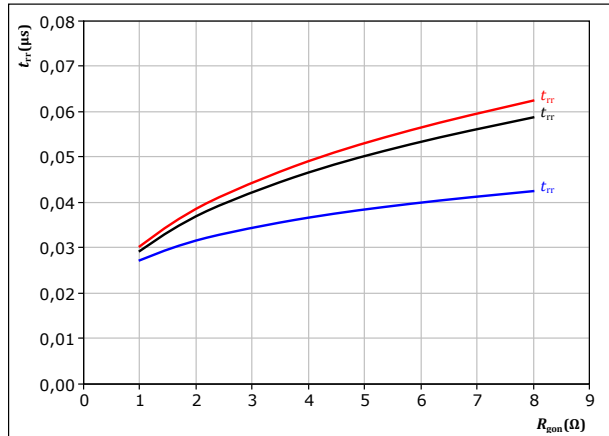


At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$  Ω  
 $T_j: 25$  °C (blue)  
 $125$  °C (black)  
 $150$  °C (red)

figure 31.

MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor  
 $t_{rr} = f(R_{gon})$



At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A  
 $T_j: 25$  °C (blue)  
 $125$  °C (black)  
 $150$  °C (red)





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# 30-EQ12NAA003MS04-PT18F76T datasheet

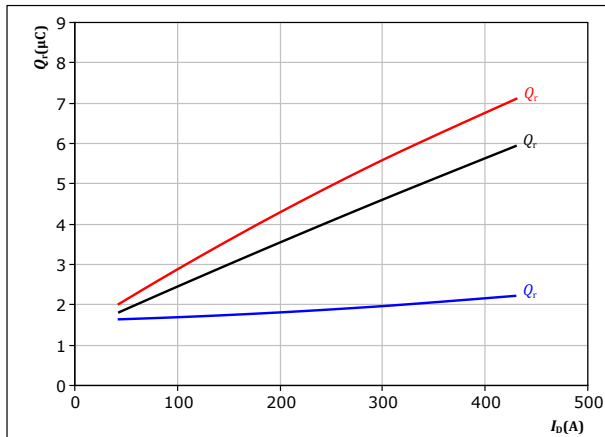
## AC Switching Characteristics

figure 32.

MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$



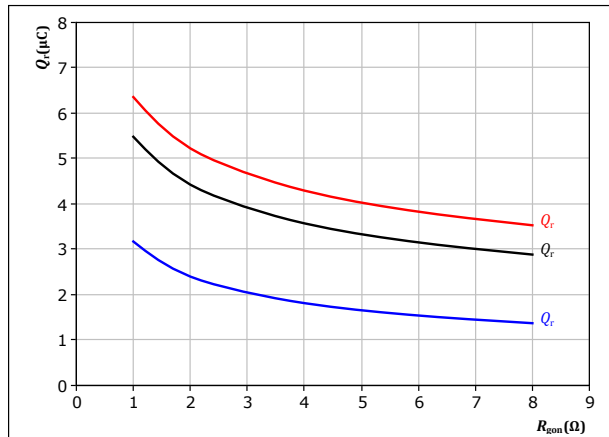
At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C  
125 °C  
150 °C

figure 33.

MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{gon})$$



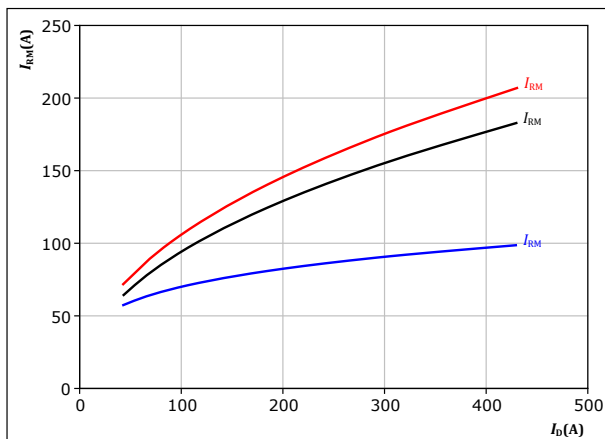
At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A  
 $T_j$ : 25 °C  
125 °C  
150 °C

figure 34.

MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



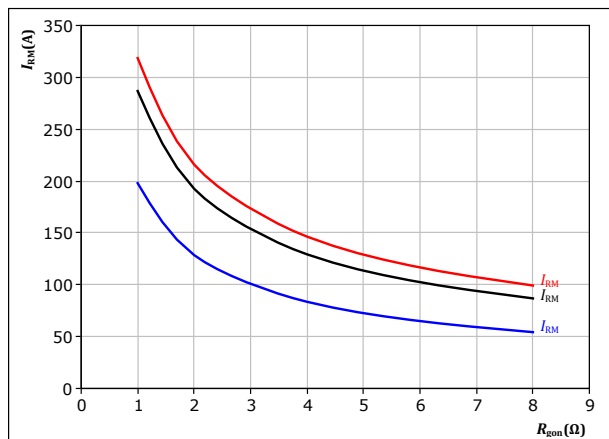
At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$   $\Omega$   
 $T_j$ : 25 °C  
125 °C  
150 °C

figure 35.

MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A  
 $T_j$ : 25 °C  
125 °C  
150 °C



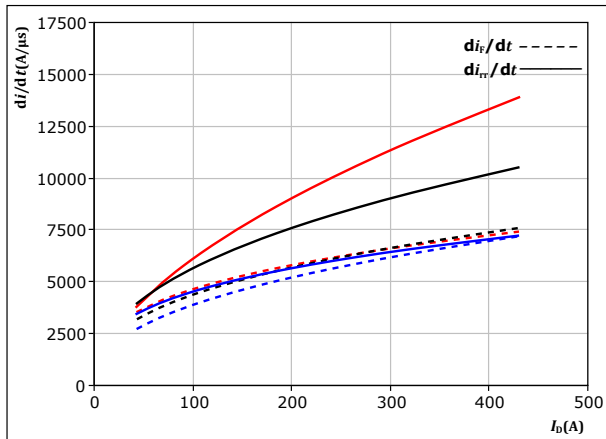
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# 30-EQ12NAA003MS04-PT18F76T datasheet

## AC Switching Characteristics

figure 36. MOSFET

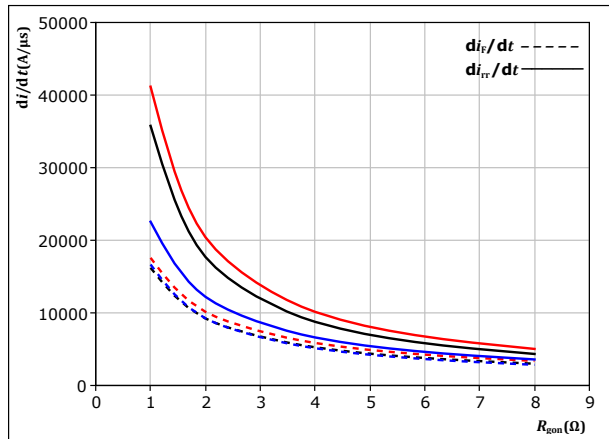
Typical rate of fall of forward and reverse recovery current as a function of drain current  
 $di_f/dt, di_r/dt = f(I_D)$



At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $R_{gon} = 4$  Ω  
 $T_j = 25$  °C  
 $T_j = 125$  °C  
 $T_j = 150$  °C

figure 37. MOSFET

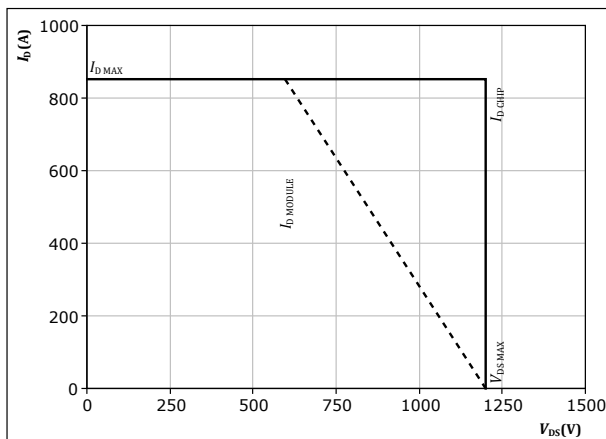
Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{gon})$



At  $V_{DS} = 600$  V  
 $V_{GS} = -5/18$  V  
 $I_D = 200$  A  
 $T_j = 25$  °C  
 $T_j = 125$  °C  
 $T_j = 150$  °C

figure 38. MOSFET

Reverse bias safe operating area  
 $I_D = f(V_{DS})$



At  $T_j = 150$  °C  
 $R_{gon} = 4$  Ω  
 $R_{goff} = 4$  Ω



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## AC Switching Definitions

figure 39. MOSFET

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

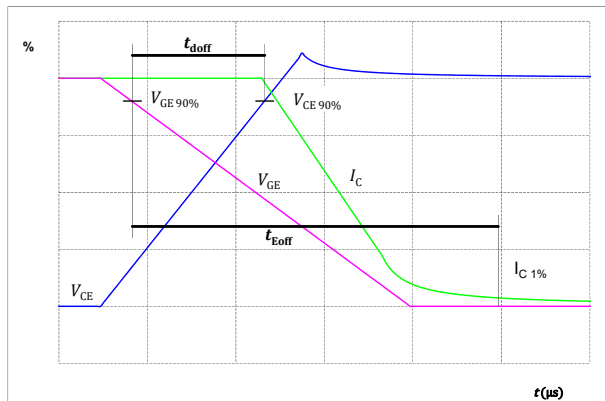


figure 40. MOSFET

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

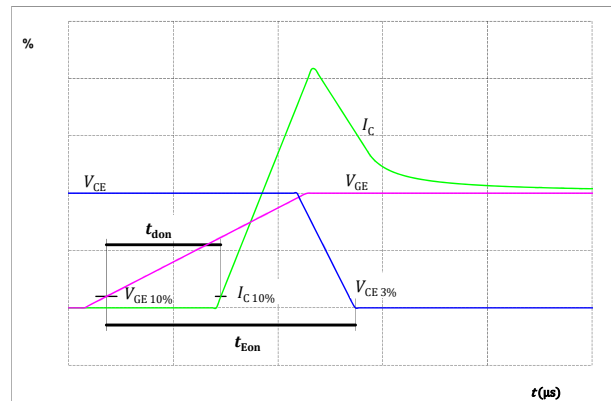


figure 41. MOSFET

Turn-off Switching Waveforms & definition of  $t_f$

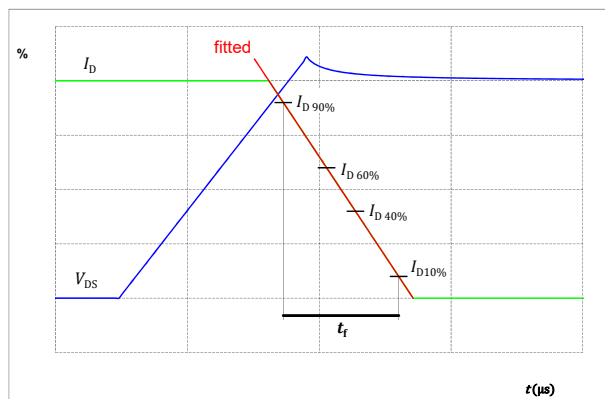
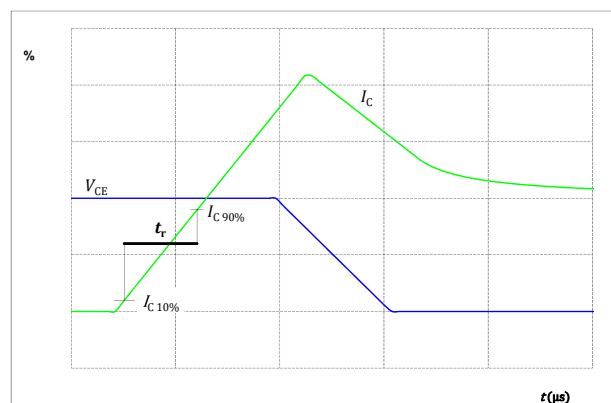


figure 42. MOSFET

Turn-on Switching Waveforms & definition of  $t_r$





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## AC Switching Definitions

figure 43.

FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

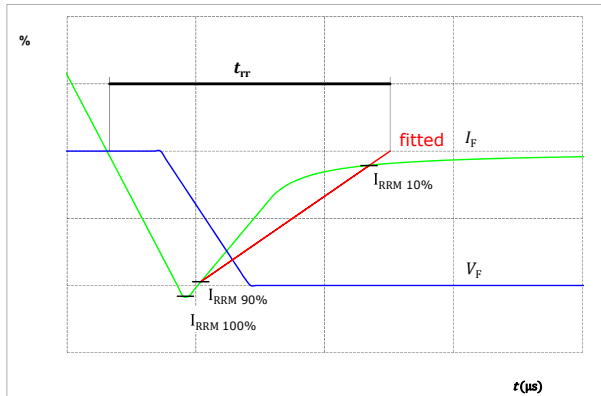


figure 44.

FWD

Turn-on Switching Waveforms & definition of  $t_{Qrr}$  ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )

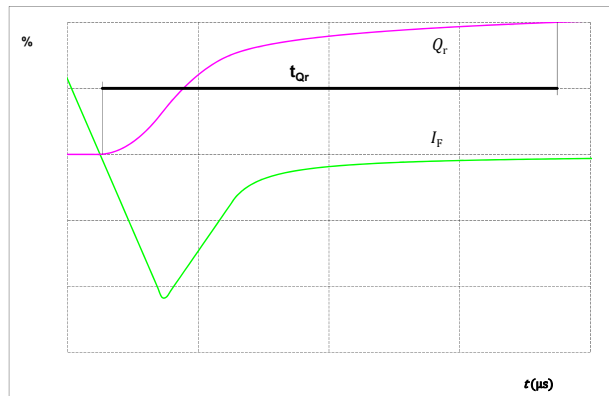
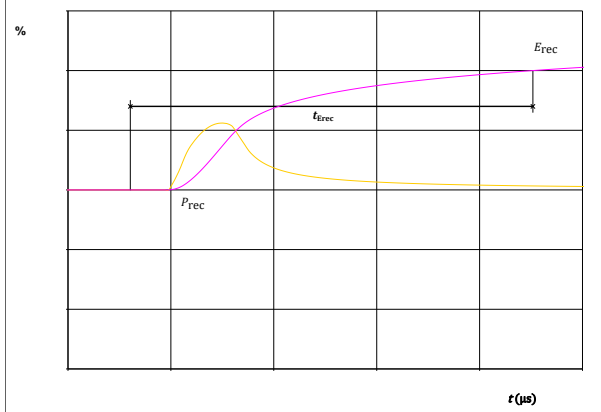


figure 45.

FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$  ( $t_{Erec}$  = integrating time for  $E_{rec}$ )





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# 30-EQ12NAA003MS04-PT18F76T

datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	30-EQ12NAA003MS04-PT18F76T
With thermal paste (5,2 W/mK, PTM6000HV)	30-EQ12NAA003MS04-PT18F76T-/7/

Marking						
	Text	Name	Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNNNNNN- TTTTWWYY	WWYY	UL VIN	LLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code	
		TTTTTWWYY	LLLLL	SSSS	WWYY	

Outline									
Pin table [mm]									
Pin	X	Y	Function	31	52,96	48	Ph		
1	0	48	Ph	32	56,16	48	Ph		
2	3,2	48	Ph	33	59,36	48	Ph		
3	6,4	48	Ph	34	62,56	48	Ph		
4	9,6	48	Ph	35	65,76	48	Ph		
5	12,8	48	Ph	36	68,96	48	Ph		
6	19,2	48	Ph	37	72,16	48	Ph		
7	22,4	48	Ph	38	40,16	3,2	GND		
8	25,6	48	Ph	39	40,16	0	GND		
9	25,6	0	GND	40	43,36	3,2	GND		
10	25,6	3,2	GND	41	43,36	0	GND		
11	28,8	0	GND	42	46,56	0	GND		
12	28,8	3,2	GND	43	62,56	3,2	DC-		
13	32	0	GND	44	62,56	0	DC-		
14	32	3,2	GND	45	65,76	3,2	DC-		
15	0	0	DC+	46	65,76	0	DC-		
16	0	3,2	DC+	47	68,96	3,2	DC-		
17	3,2	0	DC+	48	68,96	0	DC-		
18	3,2	3,2	DC+	49	72,16	3,2	DC-		
19	6,4	0	DC+	50	72,16	0	DC-		
20	6,4	3,2	DC+	51	40,16	32	N		
21	9,6	0	DC+	52	52,96	9,6	G12		
22	9,6	3,2	DC+	53	52,96	6,4	S12		
23	32	35,2	P	54	52,96	25,6	S16		
24	19,2	6,4	G15	55	52,96	22,4	G16		
25	19,2	3,2	S15	56	56,16	41,6	G14		
26	16	32	S11	57	59,36	41,6	S14		
27	16	28,8	G11	58	19,2	19,2	Therm1		
28	3,2	35,2	S13	59	19,2	16	Therm2		
29	3,2	32	G13						
30	49,76	48	Ph						

center of pin pitch (pitch)  
dimension given in mm unless otherwise stated  
for further dimensions and tolerances see the pin marking instructions

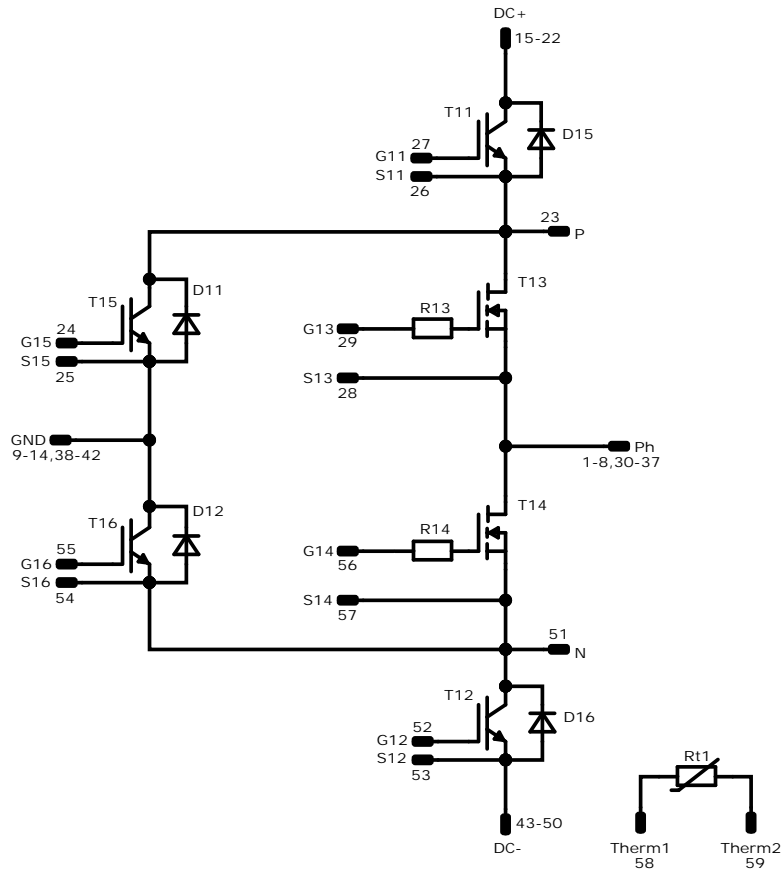
Warning of potential damage to the end of pins  
Dimension of conductive pins is only valid without pressure



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**30-EQ12NAA003MS04-PT18F76T**  
datasheet

**Pinout**




**Identification**

ID	Component	Voltage	Current	Function	Comment
T13, T14	MOSFET	1200 V	2,83 mΩ	AC Switch	
T15, T16	IGBT	1200 V	200 A	Neutral Point Switch	
D15, D16	FWD	1200 V	300 A	DC-Link Diode	
T11, T12	IGBT	1200 V	200 A	DC-Link Switch	
D11, D12	FWD	1200 V	200 A	Neutral Point Diode	
R13, R14	Resistor			Resistor (Gate)	
Rt	Thermistor			Thermistor	



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**30-EQ12NAA003MS04-PT18F76T**  
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 24	>SPQ	Standard	<SPQ	Sample
Handling instruction				
Handling instructions for <i>flow</i> E3BP packages see vincotech.com website.				
Package data				
Package data for <i>flow</i> E3BP packages see vincotech.com website.				
Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				
UL recognition and file number				
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,sp}=175^{\circ}\text{C}$ and up to 4000VAC/1min isolation voltage. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
30-EQ12NAA003MS04-PT18F76T-D1-14	8 Apr. 2026	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.